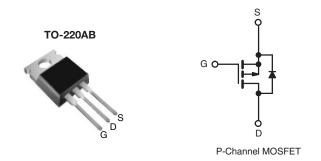


### Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	- 10	- 100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.20			
Q <sub>g</sub> (Max.) (nC)	61				
Q <sub>gs</sub> (nC)	14				
Q <sub>gd</sub> (nC)	29	29			
Configuration	Sing	Single			



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRF9540PbF	
Lead (FD)-life	SiHF9540-E3	
SnPb	IRF9540	
SIFD	SiHF9540	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	- 100	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V at 10.V	T <sub>C</sub> = 25 °C		- 19		
	V <sub>GS</sub> at - 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		- 13	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 72		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	640	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 19	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	15	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	150	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	] [	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 2.7 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 19 A (see fig. 12).
- c.  $I_{SD} \le$  19 A,  $dI/dt \le$  200 A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 1\bar{7}5$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0		

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	- 100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = -1 mA		- 0.087	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA		-	- 4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V	V <sub>GS</sub> = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 0 V V <sub>DS</sub> = - 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	- 100 - 500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}$	I <sub>D</sub> = - 11 A <sup>b</sup>	-	_	0.20	Ω
Forward Transconductance	9fs		50 V, I <sub>D</sub> = - 11 A <sup>b</sup>	6.2	_	-	S
Dynamic	315	- 53					
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0  MHz,  see fig. 5		_	1400	_	pF
Output Capacitance	C <sub>oss</sub>			-	590	_	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	140	-	
Total Gate Charge	Qg		$V_{GS} = -10 \text{ V}$ $I_D = -19 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	61	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		-	-	14	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	29	
Turn-On Delay Time	t <sub>d(on)</sub>				16	-	- ns
Rise Time	t <sub>r</sub>	$V_{DD} =  50 \text{ V}, I_D =  19 \text{ A},$ $R_g = 9.1 \Omega, R_D = 2.4 \Omega, \text{ see fig. } 10^b$		=	73	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	34	-	
Fall Time	t <sub>f</sub>			-	57	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	es						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	- 19	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 72	- A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = - 19 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	- 5.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 19 A, dl/dt = 100 A/μs <sup>b</sup>		-	130	260	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.35	0.70	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turi	-on is dominated by L <sub>S</sub> and L <sub>D</sub> )			LD)	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300 \,\mu\text{s}$ ; duty cycle  $\leq 2 \,\%$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

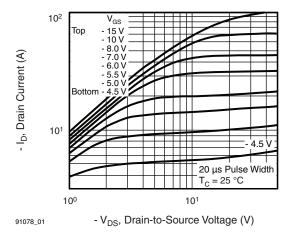


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

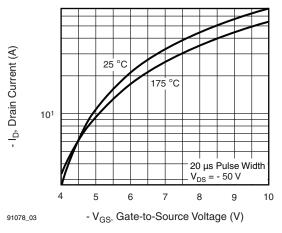


Fig. 3 - Typical Transfer Characteristics

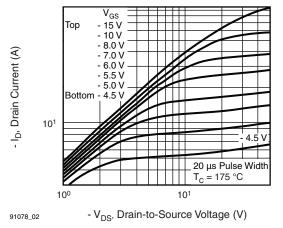


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175  $^{\circ}$  C

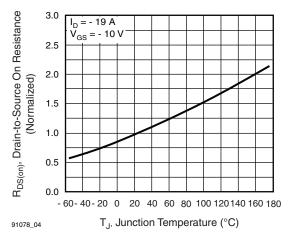


Fig. 4 - Normalized On-Resistance vs. Temperature



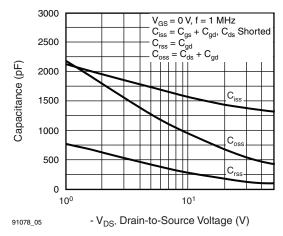


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

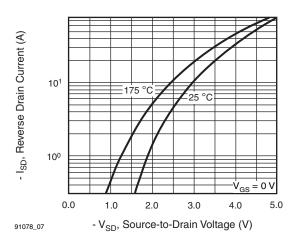


Fig. 7 - Typical Source-Drain Diode Forward Voltage

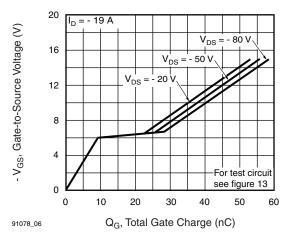


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

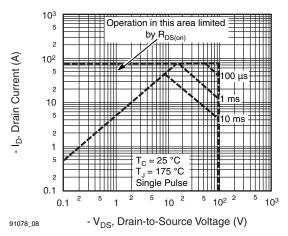


Fig. 8 - Maximum Safe Operating Area



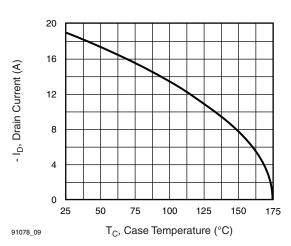


Fig. 9 - Maximum Drain Current vs. Case Temperature

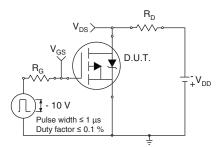


Fig. 10a - Switching Time Test Circuit

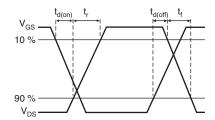


Fig. 10b - Switching Time Waveforms

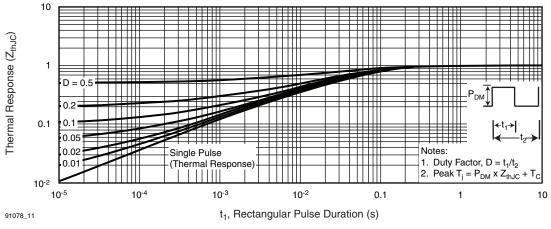


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



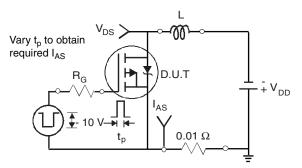


Fig. 12a - Unclamped Inductive Test Circuit

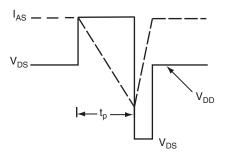


Fig. 12b - Unclamped Inductive Waveforms

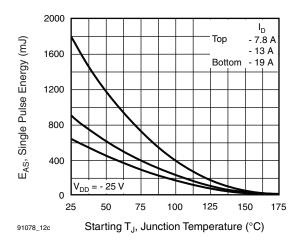


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

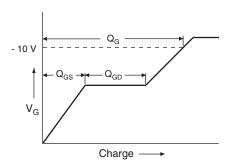


Fig. 13a - Basic Gate Charge Waveform

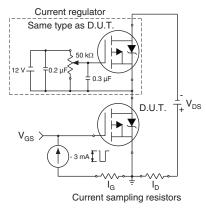
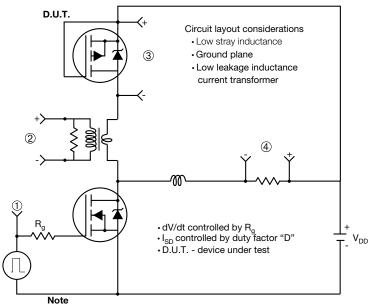


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



Compliment N-Channel of D.U.T. for driver

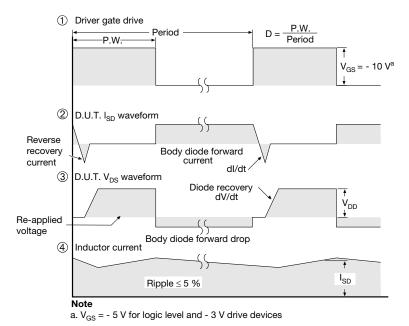


Fig. 14 - For P-Channel

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